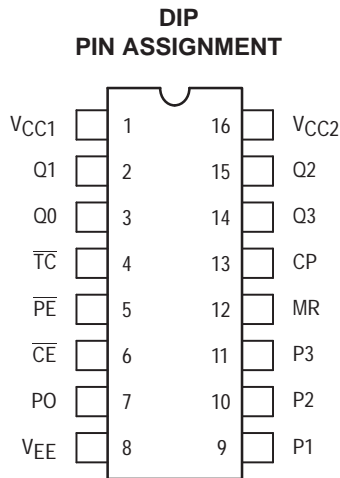


# MC10H016

## 4-Bit Binary Counter

The MC10H016 is a high-speed synchronous, presettable, cascadable 4-bit binary counter. It is useful for a large number of conversion, counting and digital integration applications.

- Counting Frequency, 200 MHz Minimum
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible
- Positive Edge Triggered



Pin assignment is for Dual-in-Line Package.  
For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).

### TRUTH TABLE

CE	PE	MR	CP	Function
L	L	L	Z	Load Parallel (P <sub>n</sub> to Q <sub>n</sub> )
H	L	L	Z	Load Parallel (P <sub>n</sub> to Q <sub>n</sub> )
L	H	L	Z	Count
H	H	L	Z	Hold
X	X	L	ZZ	Masters Respond; Slaves Hold
X	X	H	X	Reset (Q <sub>n</sub> = LOW, TC-bar = HIGH)

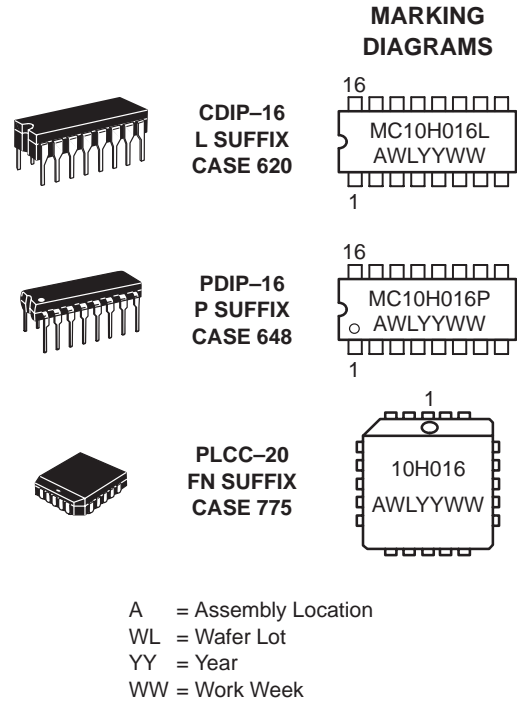
Z = Clock Pulse (Low to High); ZZ = Clock Pulse (High to Low)

Features include assertion inputs and outputs on each of the four master/slave counting flip-flops. Terminal count is generated internally in a manner that allows synchronous loading at nearly the speed of the basic counter.



**ON Semiconductor**

<http://onsemi.com>



### ORDERING INFORMATION

Device	Package	Shipping
MC10H016L	CDIP-16	25 Units/Rail
MC10H016P	PDIP-16	25 Units/Rail
MC10H016FN	PLCC-20	46 Units/Rail

# MC10H016

## MAXIMUM RATINGS

Symbol	Characteristic	Rating	Unit
V <sub>EE</sub>	Power Supply (V <sub>CC</sub> = 0)	-8.0 to 0	Vdc
V <sub>I</sub>	Input Voltage (V <sub>CC</sub> = 0)	0 to V <sub>EE</sub>	Vdc
I <sub>out</sub>	Output Current - Continuous - Surge	50 100	mA
T <sub>A</sub>	Operating Temperature Range	0 to +75	°C
T <sub>stg</sub>	Storage Temperature Range - Plastic - Ceramic	-55 to +150 -55 to +165	°C

## ELECTRICAL CHARACTERISTICS (V<sub>EE</sub> = -5.2 V ±5%) (See Note 1.)

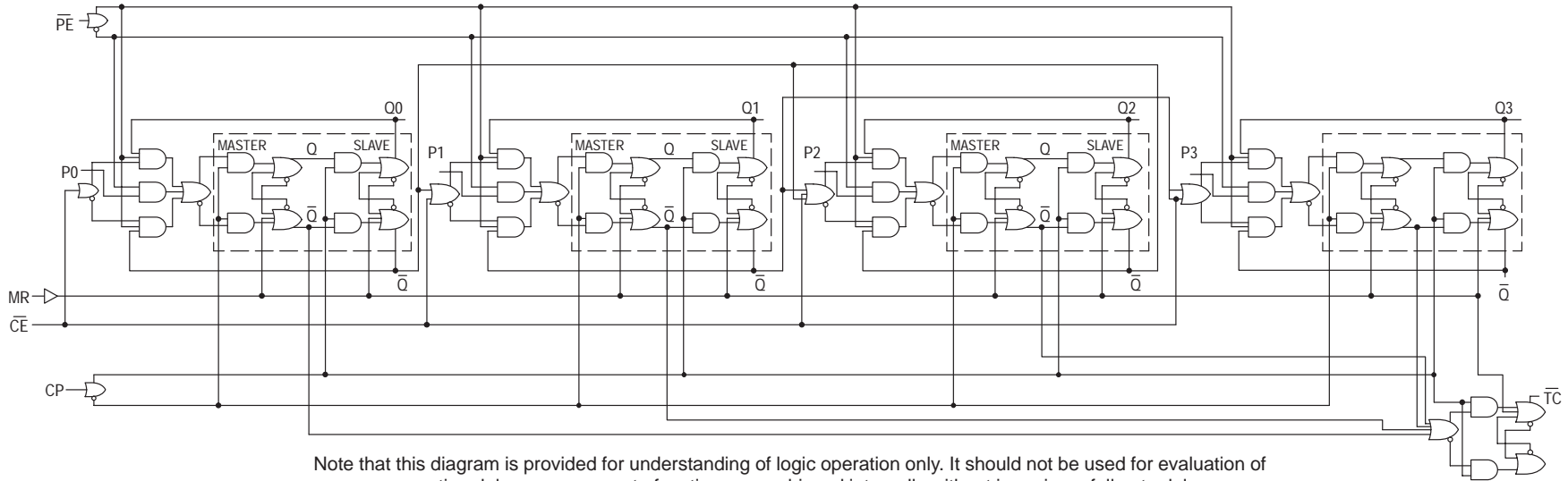
Symbol	Characteristic	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
I <sub>E</sub>	Power Supply Current	-	126	-	115	-	126	mA
I <sub>inH</sub>	Input Current High All Except MR Pin 12 MR	-	450 1190	-	265 700	-	265 700	μA
I <sub>inL</sub>	Input Current Low	0.5	-	0.5	-	0.3	-	μA
V <sub>OH</sub>	High Output Voltage	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
V <sub>OL</sub>	Low Output Voltage	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
V <sub>IH</sub>	High Input Voltage	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
V <sub>IL</sub>	Low Input Voltage	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

## AC PARAMETERS

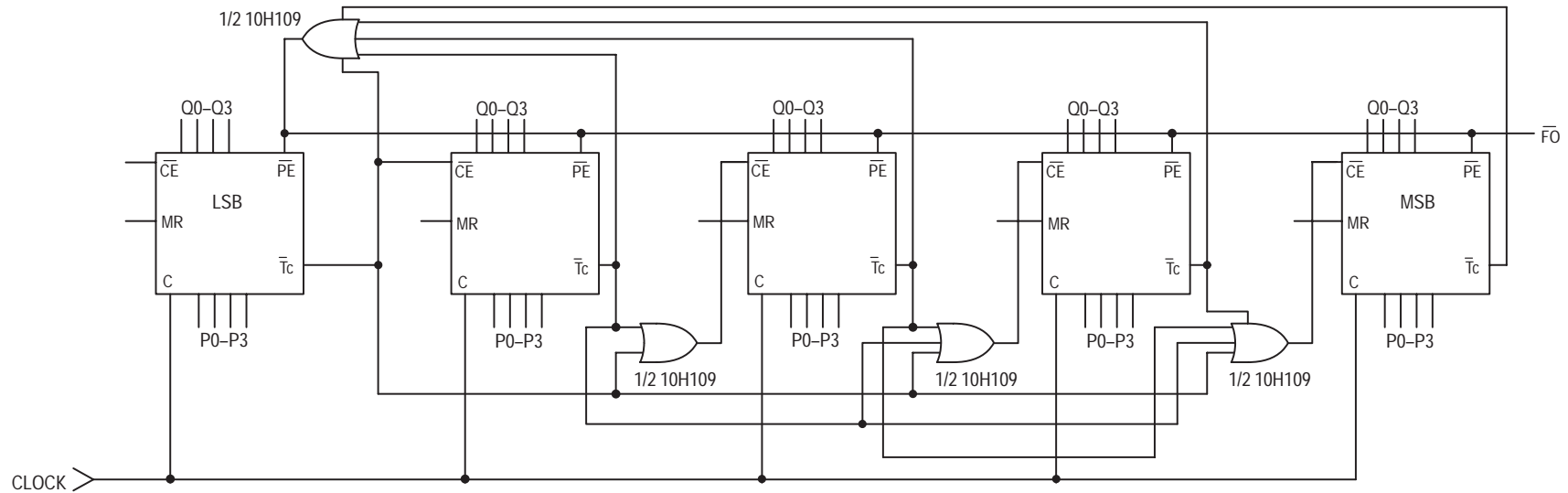
t <sub>pd</sub>	Propagation Delay	Clock to Q	1.0	2.4	1.0	2.5	1.0	2.7	ns
		Clock to $\overline{TC}$	0.7	2.4	0.7	2.5	0.7	2.6	
		MR to Q	0.7	2.4	0.7	2.5	0.7	2.6	
t <sub>set</sub>	Set-up Time	P <sub>n</sub> to Clock	2.0	-	2.0	-	2.0	-	ns
		CE or PE to Clock	2.5	-	2.5	-	2.5	-	
t <sub>hold</sub>	Hold Time	Clock to P <sub>n</sub>	1.0	-	1.0	-	1.0	-	ns
		Clock to CE or PE	0.5	-	0.5	-	0.5	-	
f <sub>count</sub>	Counting Frequency	200	-	200	-	200	-	MHz	
t <sub>r</sub>	Rise Time	0.5	2.0	0.5	2.1	0.5	2.2	ns	
t <sub>f</sub>	Fall Time	0.5	2.0	0.5	2.1	0.5	2.2	ns	

- Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

### 4-Bit Binary Counter Logic Diagram



Note that this diagram is provided for understanding of logic operation only. It should not be used for evaluation of propagation delays as many gate functions are achieved internally without incurring a full gate delay.



$\div N$  Counter 1 to 16<sup>5</sup>

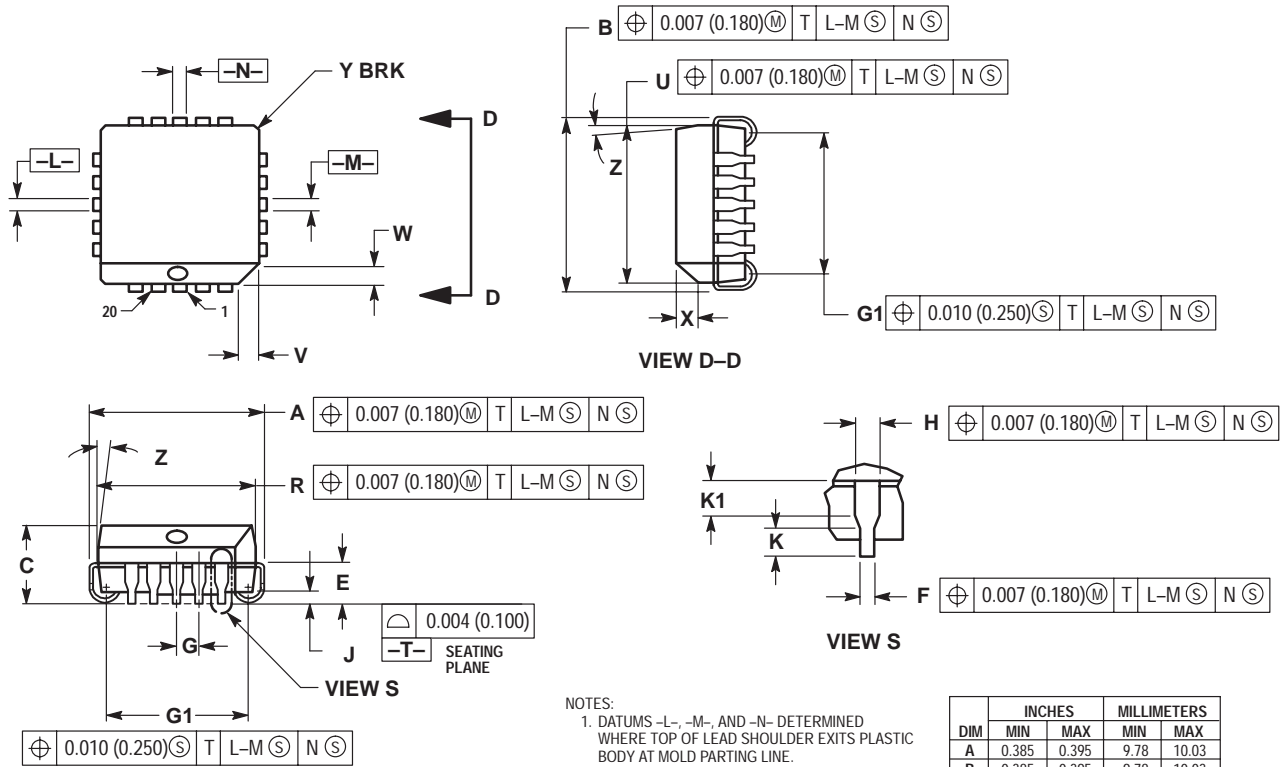
### MC10H016 Cascaded for 5 Stage Presettable Counter

Max freq. is only OR gate delay below max when counting alone.

# MC10H016

## PACKAGE DIMENSIONS

PLCC-20  
FN SUFFIX  
PLASTIC PLCC PACKAGE  
CASE 775-02  
ISSUE C



### NOTES:

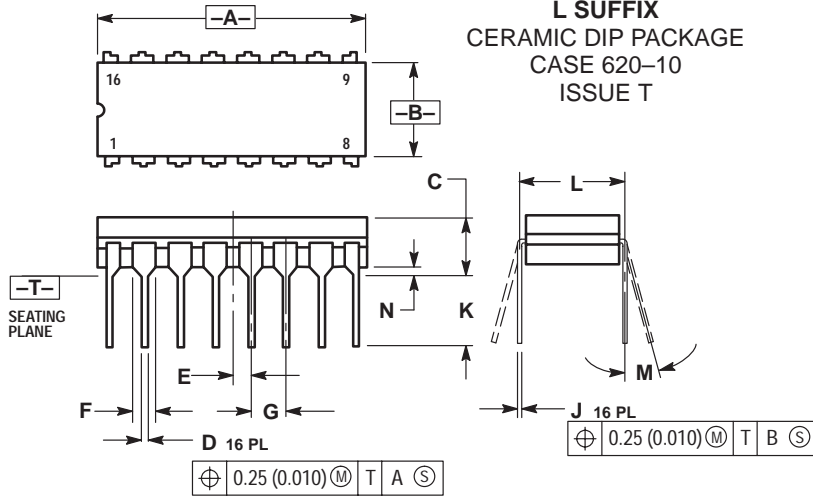
- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	---	0.51	---
K	0.025	---	0.64	---
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	---	0.020	---	0.50
Z	2°	10°	2°	10°
G1	0.310	0.330	7.88	8.38
K1	0.040	---	1.02	---

# MC10H016

## PACKAGE DIMENSIONS

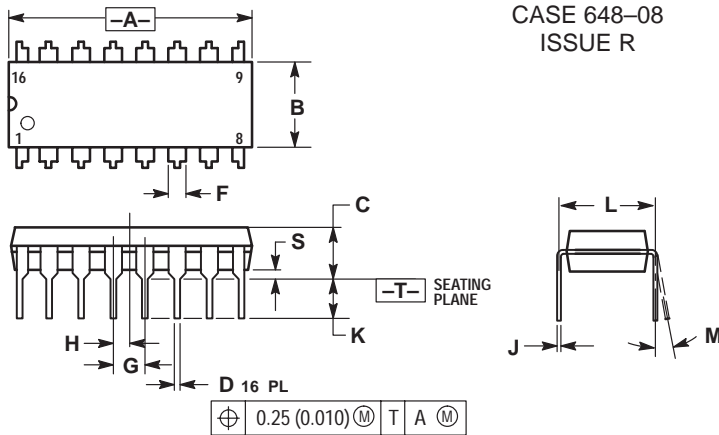
### CDIP-16 L SUFFIX CERAMIC DIP PACKAGE CASE 620-10 ISSUE T



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
  4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	---	0.200	---	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

### PDIP-16 P SUFFIX PLASTIC DIP PACKAGE CASE 648-08 ISSUE R



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
  4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
  5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

**Notes**

**Notes**

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